

NS6130-10-1023

Quick Facts

Product	:	TiCuPdZr Sputtering Target
Stock No	:	NS6130-10-1023
Purity	:	>99.9%
Molecular Formula	:	TiCuPdZr

Technical Specification

Diameter	Thickness
50.8 mm \pm 1mm	3 mm \pm 0.5mm

Titanium Copper Palladium Zirconium (TiCuPdZr) alloy sputtering target has a range of applications in the semiconductor and electronics industries. TiCuPdZr alloy sputtering target is a versatile material that has a range of applications in the semiconductor, electronics, aerospace, and biomedical industries. Its unique combination of properties, including high strength, corrosion resistance, thermal stability, and magnetic properties, make it a valuable material for use in these applications.



* This image is for graphic purposes only and does not represent the actual product.

